

APPROVAL SHEET

RFBPB 2012(0805) Series – RoHS Compliance

MULTILAYER CERAMIC BAND PASS FILTER

- Balanced Type

Halogens Free Product

2.4 GHz ISM Band Working Frequency

P/N: RFBPB2012090A9T

*Contents in this sheet are subject to change without prior notice.

FEATURES

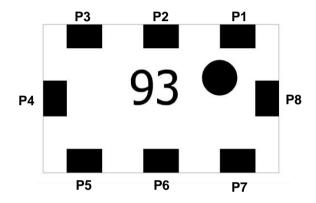
- 1. Miniature footprint: 2.0 X 1.2 X 0.9 mm³
- 2. Low Profile Thickness
- 3. Low Insertion loss
- 4. High Rejection Rate
- 5. High attenuation on 2nd harmonic suppressed
- 6. Allowable for DC biasing.
- 7. LTCC process

APPLICATIONS

- 1. 2.4GHz ISM band RF applications
- 2. Bluetooth, Wireless LAN 802.11b/g/n, HomeRF

CONSTRUCTION

Top view



PIN	Definition	PIN	Definition
P1	Unbalance Port	P5	Balance Port
P2	DC/GND	P6	GND
Р3	NC	P7	Balance Port
P4	GND	P8	GND

DIMENSIONS

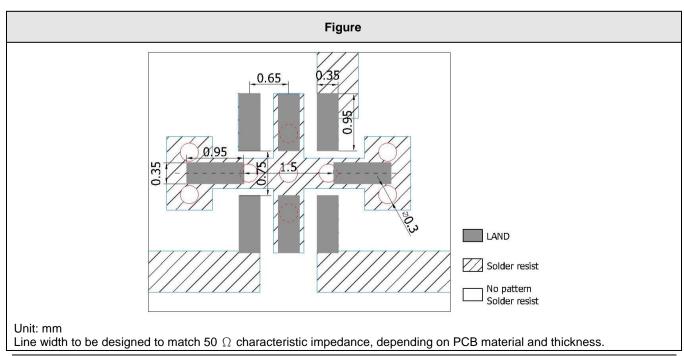
Figure	Symbol	Dimension (mm)
_ L	L	2.00± 0.15
Top view 93 • •	W	1.25 ± 0.10
W 33 U	Т	0.90±0.10
	А	0.20 ± 0.15
Bottom view	В	0.30 ± 0.10
	С	0.35 ± 0.10
D C B A Side view	D	0.65 ± 0.10
Side view	E	0.20 ± 0.15
	F	0.20 ± 0.15
	G	0.30 ± 0.10



ELECTRICAL CHARACTERISTICS

RFBPB2012090A9T	Specification		
Frequency range	2400 ~ 2500 MHz		
Insertion Loss	2.8 dB max.		
Phase Difference	180° ± 10°		
Amplitude Difference	2 .0 dB Max		
Attenuation	35dB min. @ 880 ~ 960 MHz 30dB min. @ 1575 MHz 25dB min. @ 1710~1880 MHz 30dB min. @ 4800~5000 MHz		
VSWR	2.1 max.		
Impedance (Unbalanced)	50 Ω		
Impedance (Balanced)	Conjugate match to BC series of Bluetooth chipset		
Operation Temperature Range	-40°C ~ +85 °C		
Moisture sensitivity levels LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)			
Typical Electrical Chart			
0 -10 (gg) -20 (sg) -20 -40 -40 -50 -60 -70 0 1 2 3 4 5 6	Amplitude Difference Phase Difference Phase Difference 170 180 170 160 2.2 2.3 2.4 2.5 2.6 2.7 2.8		
freq, GHz	freq, GHz		

SOLDER LAND PATTERN





RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature: 235 ± 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time: 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching	*Solder bath temperature : 260 ± 5°C	Loss of metallization on the edges of each
(Resistance to	*Leaching immersion time : 30 ± 0.5 sec	electrode shall not exceed 25%.
dissolution of	Solder : SN63A	electrode shall not exceed 25%.
metallization)		
IEC 60068-2-58		
Resistance to soldering heat	*Preheating temperature : 120~150°€,	No mechanical damage.
JIS C 0050-5.4	1 minute.	Electrical specification shall satisfy the
	*Solder temperature: 270±5°C	descriptions in electrical characteristics under
	*Immersion time: 10±1 sec	the operational temperature range within -40
		~ 85°C.
	Solder : Sn3Ag0.5Cu for lead-free	Loss of metallization on the edges of each
	Measurement to be made after keeping at	electrode shall not exceed 25%.
	room temperature for 24±2 hrs	
Drop Test	*Height: 75 cm	No mechanical damage.
JIS C 0044	*Test Surface : Rigid surface of concrete or	Electrical specification shall satisfy the
Customer's specification.	steel.	descriptions in electrical characteristics under
	*Times: 6 surfaces for each units; 2 times	the operational temperature range within -40
	for each side.	~ 85°C.
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Vibration	*Frequency: 10Hz~55Hz~10Hz(1min)	No mechanical damage.
JIS C 0040	*Total amplitude : 1.5mm	Electrical specification shall satisfy the
	*Test times : 6hrs.(Two hrs each in three	descriptions in electrical characteristics under
	mutually perpendicular directions)	the operational temperature range within -40
		~ 85°C.
Adhesive Strength	*Pressurizing force :	No remarkable demand or remarkable the
of Termination	5N(≤0603) ; 10N(>0603)	No remarkable damage or removal of the termination.
JIS C 0051- 7.4.3		termination.
Bending test	*Test time: 10±1 sec	
JIS C 0051- 7.4.1	The middle part of substrate shall be	No mechanical damage.
7.5 0 0001 1.T.1	pressurized by means of the pressurizing rod	Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	

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Temperature cycle JIS C 0025	 30±3 minutes at -40°C±3°C, 10~15 minutes at room temperature, 30±3 minutes at +85°C±3°C, 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs 	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
High temperature JIS C 0021 Humidity (steady conditions) JIS C 0022	*Temperature: 85°C±2°C *Test duration: 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs *Humidity: 90% to 95% R.H. *Temperature: 40±2°C	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under
	*Time: 1000+24/-0 hrs. Measurement to be made after keeping at room temperature for 24±2 hrs	the operational temperature range within -40 ~ 85°C.
JIS C 0020	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

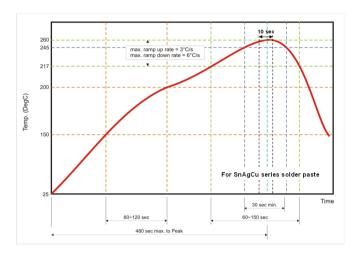


Fig 2. Infrared soldering profile

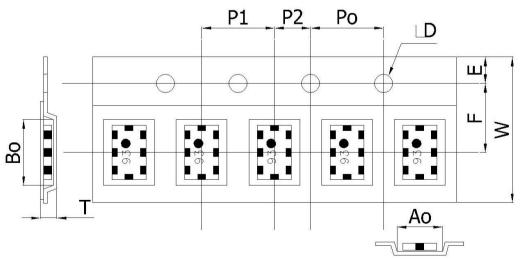
ORDERING CODE

RF	ВРВ	201209	0	Α	9	Т
Walsin	Product Code	Dimension code	Unit of	Application	Specification	Packing
RF device	BPB:	Per 2 digits of Length,	dimension	A : 2.4GHZ	Design Code	T: 7" Reeled
	Balanced Type	Width, Thickness:	0 : 0.1 mm	ISM Band		
	Band Pass Filter	e.g. :	1 : 1.0 mm			
		201209 =				
		Length 20,				
		Width 12,				
		Thickness 0.9				

Minimum Ordering Quantity: 2000 pcs per reel.

By 7" Reeled package

PACKAGING

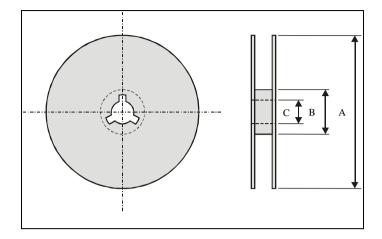


Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	1.35 ± 0.10	2.30 ± 0.10	1.55 ± 0.10	0.95 ± 0.10	8.00 ± 0.30
Index	Е	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10



Reel dimensions



Index	Α	В	С
Dimension (mm)	Ф178	Ф60.0	Ф13.5

Typing Quantity: 2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : -10 to +40 $^{\circ}$ C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.